

SEMITRANS[®] 3

Trench IGBT Modules

SKM600GAL07E3

Features*

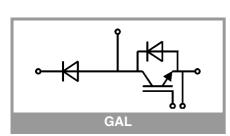
- V_{CE(sat)} with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_{cnom}
- Fast & soft switching inverse CAL diodes
- Insulated copper baseplate using DCB Technology (Direct Copper Bonding)
- With integrated gate resistor

Typical Applications

- Electronic welders
- DC/DC converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to T_c = 125°C max.
- Recommended $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T_j = 150°C
- Use of soft R_G necessary



| Absolute | Maximum Rating | s | | |
|---------------------|--|---------------------------|---------|------|
| Symbol | Conditions | | Values | Unit |
| IGBT | | | | |
| V _{CES} | T _j = 25 °C | | 650 | V |
| lc | T 175 % | T _c = 25 °C | 852 | А |
| | − T _j = 175 °C | T _c = 80 °C | 644 | A |
| I _{Cnom} | | - | 600 | Α |
| I _{CRM} | | | 1800 | Α |
| V _{GES} | | | -20 20 | V |
| t _{psc} | $V_{CC} = 360 V$ $V_{GE} \le 15 V$ $V_{CES} \le 650 V$ | T _j = 150 °C | 6 | μs |
| Tj | | _ | -40 175 | °C |
| Inverse d | iode | | · | |
| V _{RRM} | T _j = 25 °C | | 650 | V |
| I _F | T _i = 175 °C | T _c = 25 °C | 812 | А |
| | $=1_{j}=175$ C | T _c = 80 °C | 595 | А |
| I _{Fnom} | | | 600 | А |
| I _{FRM} | | | 1200 | А |
| I _{FSM} | $t_p = 10 \text{ ms}, \sin 180^\circ, T_j = 25 ^\circ\text{C}$ | | 4320 | Α |
| Tj | | | -40 175 | °C |
| Freewhee | eling diode | | | |
| V _{RRM} | T _j = 25 °C | | 650 | V |
| l _F | T _i = 175 °C | T _c = 25 °C | 812 | А |
| | $1_j = 175 \text{ C}$ | T _c = 80 °C | 595 | А |
| I _{Fnom} | | | 600 | А |
| I _{FRM} | | | 1200 | А |
| I _{FSM} | t _p = 10 ms, sin 180 | °, T _j = 25 °C | 4320 | А |
| Tj | | | -40 175 | °C |
| Module | | | | |
| I _{t(RMS)} | | | 500 | А |
| T _{stg} | module without TI | N | -40 125 | °C |
| Visol | AC sinus 50 Hz, t = | = 1 min | 4000 | V |

| Characte | ristics | | | | | |
|----------------------|---|-------------------------|------|------|------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| V _{CE(sat)} | $I_{C} = 600 \text{ A}$ $V_{GE} = 15 \text{ V}$ chiplevel | T _j = 25 °C | | 1.45 | 1.90 | V |
| | | T _j = 150 °C | | 1.70 | 2.10 | V |
| V _{CE0} | chiplevel | T _j = 25 °C | | 0.90 | 1.00 | V |
| | | T _j = 150 °C | | 0.82 | 0.90 | V |
| - | V _{GE} = 15 V | T _j = 25 °C | | 0.92 | 1.50 | mΩ |
| | chiplevel | T _j = 150 °C | | 1.47 | 2.00 | mΩ |
| V _{GE(th)} | $V_{GE}=V_{CE}$, $I_C = 9.6$ mA | | 5.1 | 5.8 | 6.4 | V |
| I _{CES} | $V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}, T_{j} = 25 ^{\circ}\text{C}$ | | | | 0.3 | mA |
| Cies | V _{CE} = 25 V V _{GE} = 0 V | f = 1 MHz | | 37.0 | | nF |
| Coes | | f = 1 MHz | | 2.32 | | nF |
| Cres | | f = 1 MHz | | 1.10 | | nF |
| Q _G | V _{GE} = - 8 V+ 15 V | | | 4800 | | nC |
| R _{Gint} | $T_j = 25 \ ^{\circ}C$ | | | 0.5 | | Ω |



SEMITRANS[®] 3

Trench IGBT Modules

SKM600GAL07E3

Features*

- V_{CE(sat)} with positive temperature coefficient
- + High short circuit capability, self limiting to 6 x $\rm I_{cnom}$
- Fast & soft switching inverse CAL diodes
- Insulated copper baseplate using DCB Technology (Direct Copper Bonding)
- · With integrated gate resistor

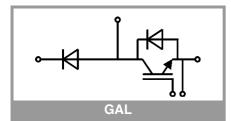
Typical Applications

- Electronic welders
- DC/DC converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to T_c = 125°C max.
- Recommended $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T_j = 150°C
- Use of soft R_G necessary

| Symbol | Conditions | | min. | tur | mov | Unit |
|----------------------|--|-------------------------|--------|-------|-------|------|
| Symbol | Conditions | | 11111. | typ. | max. | |
| IGBT | V _{CC} = 300 V | T 150 °C | 1 | 00 | | |
| t _{d(on)} | $I_{\rm C} = 600 {\rm A}$ | T _j = 150 °C | | 83 | | ns |
| t _r | V _{GE} = +15/-7.5 V | T _j = 150 °C | | 121 | | ns |
| E _{on} | $R_{G on} = 3 \Omega$ | T _j = 150 °C | | 20 | | mJ |
| t _{d(off)} | $R_{G off} = 4.3 \Omega$ | T _j = 150 °C | | 1100 | | ns |
| t _f | $di/dt_{on} = 4900 \text{ A/}\mu\text{s}$ $di/dt_{off} = 6700 \text{ A/}\mu\text{s}$ | $I_j = 150 ^{\circ}C$ | 1 | 93 | | ns |
| E _{off} | $dv/dt = 1330 V/\mu s$ L _s = 20 nH | T _j = 150 °C | | 37 | | mJ |
| R _{th(j-c)} | per IGBT | | | | 0.066 | K/W |
| R _{th(c-s)} | per IGBT (λ _{grease} =0.81 W/(m*K)) 0.033 | | | K/W | | |
| R _{th(c-s)} | per IGBT, pre-applied phase change material | | | 0.02 | | K/W |
| Inverse d | iode | | | | | |
| $V_F = V_{EC}$ | I _F = 600 A | T _j = 25 °C | | 1.40 | 1.76 | V |
| | V _{GE} = 0 V chiplevel | T _j = 150 °C | | 1.38 | 1.77 | V |
| V _{F0} | chiplevel | T _j = 25 °C | | 1.04 | 1.24 | V |
| | | T _j = 150 °C | | 0.85 | 0.99 | V |
| r _F | chiplevel | T _j = 25 °C | | 0.60 | 0.88 | mΩ |
| | | T _j = 150 °C | | 0.89 | 1.31 | mΩ |
| I _{RRM} | I _F = 600 A | T _j = 150 °C | | 390 | | Α |
| Q _{rr} | di/dt _{off} = 4940 A/μs V _{GE} = -7.5 V | T _j = 150 °C | | 54 | | μC |
| E _{rr} | $V_{GE} = -7.5 V$ $V_{CC} = 300 V$ | T _j = 150 °C | | 9.1 | | mJ |
| R _{th(j-c)} | per diode | | | | 0.096 | K/W |
| R _{th(c-s)} | per diode (λ _{grease} =0 | .81 W/(m*K)) | | 0.038 | | K/W |
| R _{th(c-s)} | per diode, pre-applied phase change material | | | 0.028 | | K/W |
| Freewhee | ling diode | | | | | |
| $V_F = V_{EC}$ | I _F = 600 A | T _i = 25 °C | | 1.40 | 1.76 | V |
| | V _{GE} = 0 V chiplevel | T _j = 150 °C | | 1.38 | 1.77 | V |
| V _{F0} | chiplevel | T _j = 25 °C | | 1.04 | 1.24 | V |
| | | T _j = 150 °C | | 0.85 | 0.99 | V |
| r _F | chiplevel | T _j = 25 °C | | 0.60 | 0.88 | mΩ |
| | | T _j = 150 °C | | 0.89 | 1.31 | mΩ |
| I _{RRM} | $I_{\rm F} = 600 {\rm A}$ | T _j = 150 °C | | 390 | | Α |
| Q _{rr} | di/dt _{off} = 4940 A/μs V _{GE} = -7.5 V | T _j = 150 °C | | 54 | | μC |
| Err | $V_{GE} = -7.5 V$ $V_{CC} = 300 V$ | T _j = 150 °C | | 9.1 | | mJ |
| R _{th(j-c)} | per diode | | | | 0.096 | K/W |
| R _{th(c-s)} | per diode (λ_{grease} =0.81 W/(m*K)) | | | 0.038 | | K/W |
| R _{th(c-s)} | per diode, pre-applied phase change material | | | 0.028 | | K/W |





SEMITRANS[®] 3

Trench IGBT Modules

SKM600GAL07E3

Features*

- V_{CE(sat)} with positive temperature coefficient
- + High short circuit capability, self limiting to 6 x $\rm I_{cnom}$
- Fast & soft switching inverse CAL diodes
- Insulated copper baseplate using DCB Technology (Direct Copper Bonding)
- With integrated gate resistor

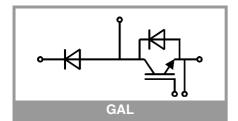
Typical Applications

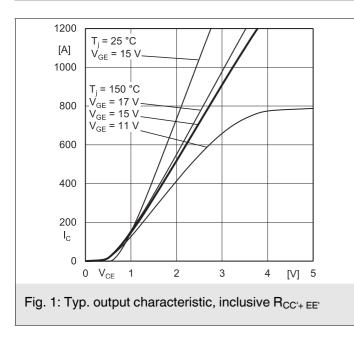
- Electronic welders
- DC/DC converter
- Brake chopper
- Switched reluctance motor

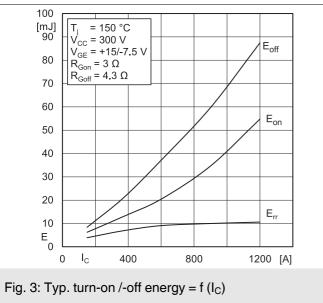
Remarks

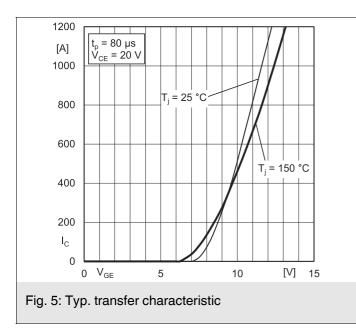
- Case temperature limited to T_c = 125°C max.
- Recommended $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T_i = 150°C
- Use of soft R_G necessary

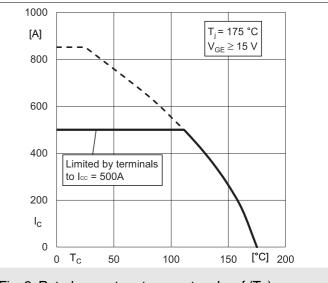
| | 1 | | 1 . | | | 1 |
|-----------------------|---|-------------------------|------|--------|------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Module | | | | | | |
| L _{CE} | | | | 15 | | nH |
| R _{CC'+EE'} | measured per switch | T _C = 25 °C | 0.55 | | | mΩ |
| | | T _C = 125 °C | 0.85 | | | mΩ |
| R _{th(c-s)1} | calculated without | thermal coupling | | 0.0177 | | K/W |
| R _{th(c-s)2} | including thermal c T _s underneath moc $(\lambda_{grease}=0.81 \text{ W/(m}))$ | n module 0.018 | | | K/W | |
| R _{th(c-s)2} | including thermal coupling, T _s underneath module, pre-applied phase change material | | | 0.012 | | K/W |
| Ms | to heat sink M6 | | 3 | | 5 | Nm |
| M _t | | to terminals M6 | 2.5 | | 5 | Nm |
| | | | | | | Nm |
| w | | | 1 | | 325 | g |

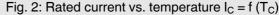


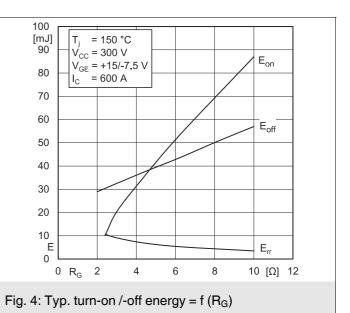


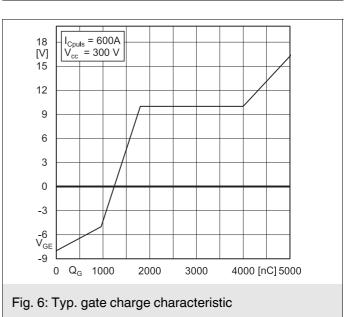




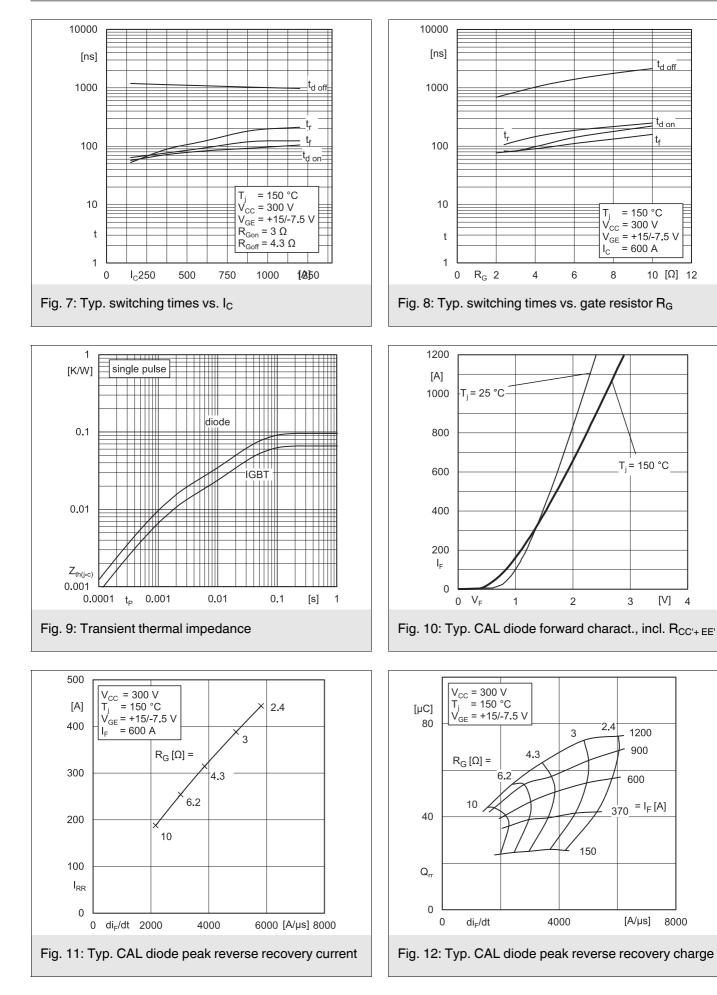








Rev. 1.0 - 29.05.2020



⁻t_{d off}

t_{d on}

10 [Ω] 12

tf

= 150 °C

T_i = 150 °C

[V]

4

3

1200

900

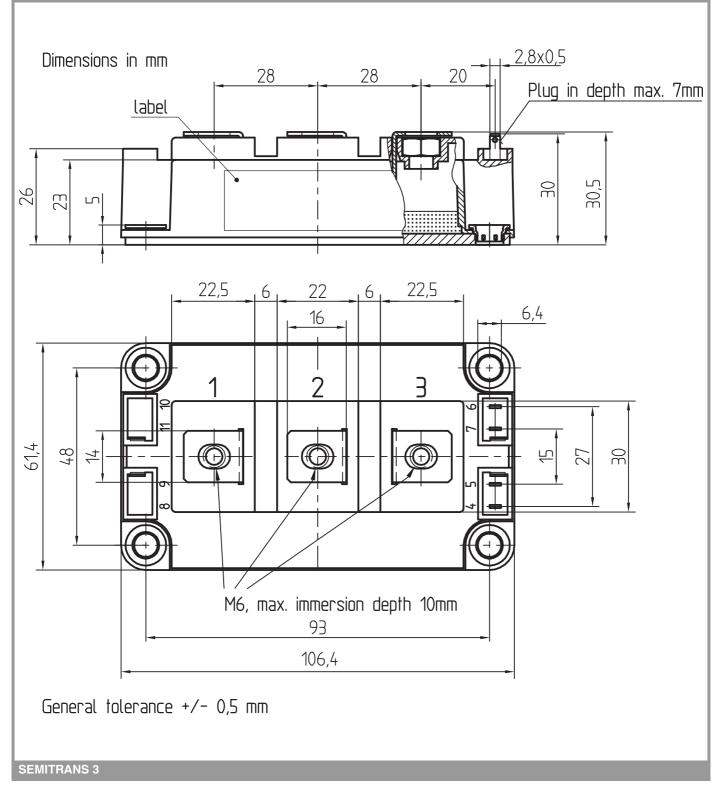
600

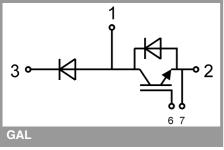
370 = I_F [A]

[A/µs]

8000

8





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

***IMPORTANT INFORMATION AND WARNINGS**

The specifications of SEMIKRON products may not be considered as guarantee or assurance of product characteristics ("Beschaffenheitsgarantie"). The specifications of SEMIKRON products describe only the usual characteristics of products to be expected in typical applications, which may still vary depending on the specific application. Therefore, products must be tested for the respective application in advance. Application adjustments may be necessary. The user of SEMIKRON products is responsible for the safety of their applications embedding SEMIKRON products and must take adequate safety measures to prevent the applications from causing a physical injury, fire or other problem if any of SEMIKRON products become faulty. The user is responsible to make sure that the application design is compliant with all applicable laws, regulations, norms and standards. Except as otherwise explicitly approved by SEMIKRON in a written document signed by authorized representatives of SEMIKRON, SEMIKRON products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury. No representation or warranty is given and no liability is assumed with respect to the accuracy, completeness and/or use of any information herein, including without limitation, warranties of non-infringement of intellectual property rights of any third party. SEMIKRON does not assume any liability arising out of the applications or use of any product; neither does it convey any license under its patent rights, copyrights, trade secrets or other intellectual property rights, nor the rights of others. SEMIKRON makes no representation or warranty of non-infringement or alleged non-infringement of intellectual property rights of any third party which may arise from applications. Due to technical requirements our products may contain dangerous substances. For information on the types in question please contact the nearest SEMIKRON sales office. This document supersedes and replaces all information previously supplied and may be superseded by updates. SEMIKRON reserves the right to make changes.